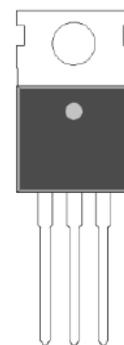


N-Channel Enhancement Mode Power MOSFET

Features:

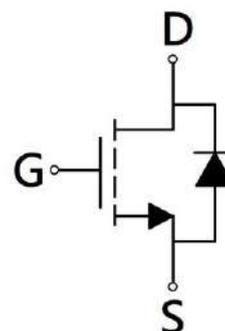
- Low On Resistance
- Low Gate Charge
- Fast Switching Characteristic

TO-220



G D S

BV_{DSS}	100V
$I_D @ V_{GS}=10V, T_C=25^\circ C$	130A
$I_D @ V_{GS}=10V, T_A=25^\circ C$	22A
$R_{DS(ON)} @ V_{GS}=10V, I_D=20A$	3.2m Ω



G : Gate S : Source D : Drain

Ordering Information

Device	Package	Shipping
KE3D0N10R	TO-220 (Pb-free lead plating package)	50 pcs/tube, 20 tubes/box, 5 boxes / carton

Absolute Maximum Ratings (T_A=25°C)

Parameter	Symbol	Limits	Unit	
Drain-Source Voltage	V _{DS}	100	V	
Gate-Source Voltage	V _{GS}	±20		
Continuous Drain Current @ V _{GS} =10V, T _C =25°C	I _D	130	A	
Continuous Drain Current @ V _{GS} =10V, T _C =100°C		84		
Continuous Drain Current @ V _{GS} =10V, T _A =25°C		22		
Continuous Drain Current @ V _{GS} =10V, T _A =70°C		18		
Pulsed Drain Current		I _{DM}		520
Continuous Body Diode Forward Current @ T _C =25°C	I _S	104		
Avalanche Current @ L=0.1mH	I _{AS}	40		
Avalanche Energy @ L=0.5mH	E _{AS}	100	mJ	
Total Power Dissipation	P _D	T _C =25°C	125	W
		T _C =100°C	50	
		T _A =25°C	3.6	
		T _A =70°C	2.3	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150	°C	

Thermal Data

Parameter	Symbol	Steady State	Unit
Thermal Resistance, Junction-to-case	R _{θJC}	1	°C/W
Thermal Resistance, Junction-to-ambient	R _{θJA}	34	

Note:

- *a. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- *b. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2 oz. copper, in a still air environment with T_A=25°C. The power dissipation P_D is based on R_{θJA} and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- *c. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and low duty cycles to keep initial T_J=25°C.

Electrical Characteristics (T_A=25°C, unless otherwise specified)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV _{DSS}	100	-	-	V	V _{GS} =0V, I _D =250μA
V _{GS(th)}	2	-	4		V _{DS} =V _{GS} , I _D =250μA
G _{FS}	-	37.7	-	S	V _{DS} =10V, I _D =20A
I _{GSS}	-	-	±100	nA	V _{GS} =±20V, V _{DS} =0V
I _{DSS}	-	-	1	μA	V _{DS} =80V, V _{GS} =0V
R _{DS(ON)}	-	3.2	4	mΩ	V _{GS} =10V, I _D =20A
Dynamic					
C _{iss}	-	6200	-	pF	V _{DS} =50V, V _{GS} =0V, f=1MHz
C _{oss}	-	860	-		
C _{rss}	-	40	-		
R _g	-	0.9	-	Ω	f=1MHz
Q _g *1, 2	-	90	-	nC	V _{DS} =50V, I _D =20A, V _{GS} =10V
Q _{gs} *1, 2	-	30	-		
Q _{gd} *1, 2	-	20	-		
t _{d(ON)} *1, 2	-	42	-	ns	V _{DS} =50V, I _D =20A, V _{GS} =10V, R _{GS} =1.6Ω
t _r *1, 2	-	25	-		
t _{d(OFF)} *1, 2	-	70	-		
t _f *1, 2	-	20	-		
Source-Drain Diode					
V _{SD} *1	-	0.82	1.2	V	I _S =20A, V _{GS} =0V
t _{rr}	-	63	-	ns	I _F =20A, dI _F /dt=100A/μs
Q _{rr}	-	135	-	nC	

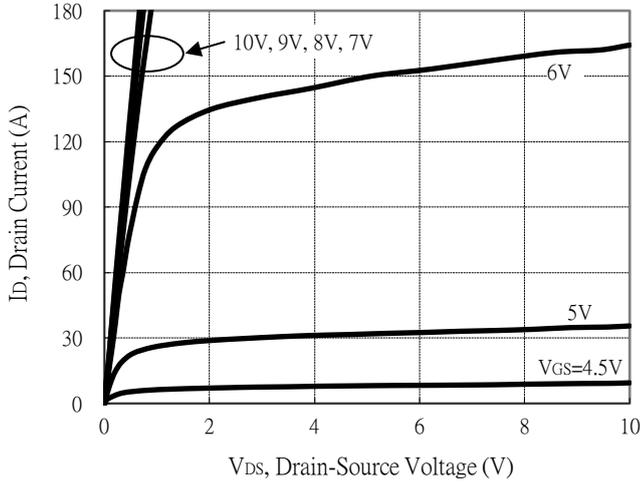
Note:

*1. Pulse Test : Pulse Width ≤300μs, Duty Cycle ≤2%

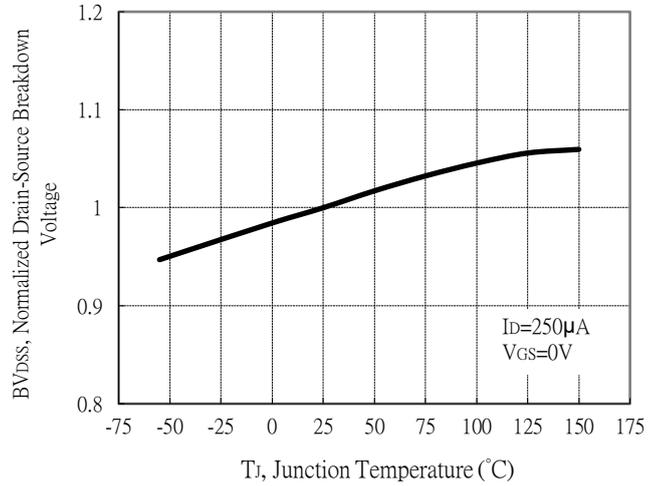
*2. Independent of operating temperature

Typical Characteristics

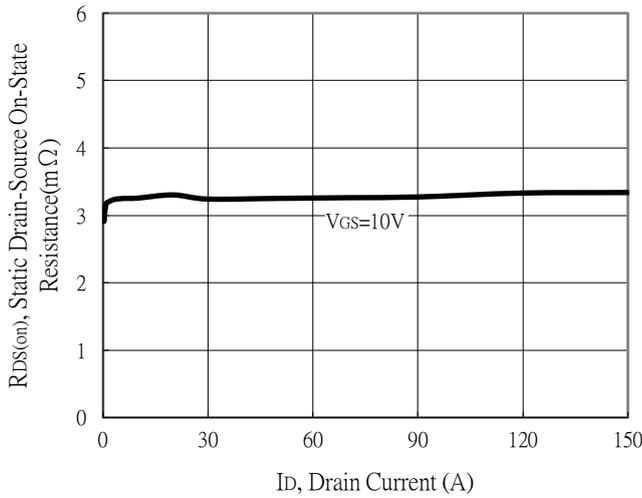
Typical Output Characteristics



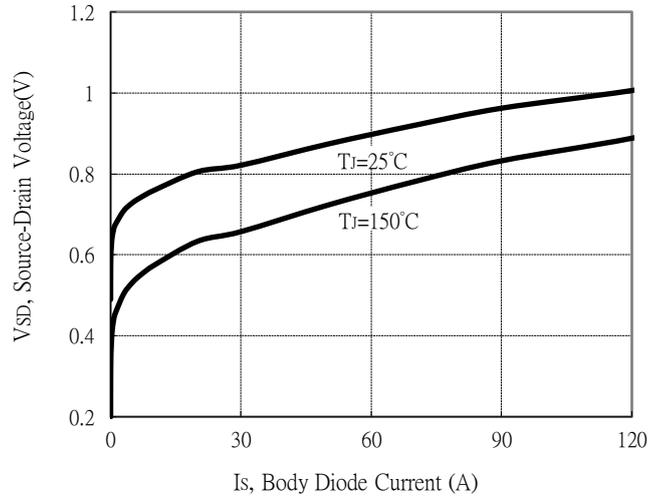
Breakdown Voltage vs Ambient Temperature



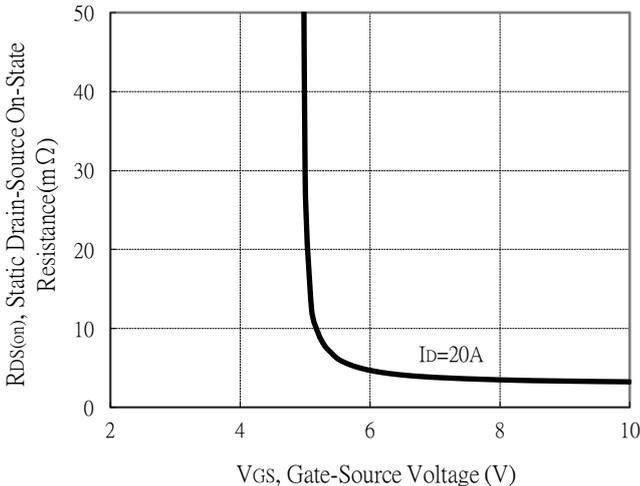
Static Drain-Source On-State resistance vs Drain Current



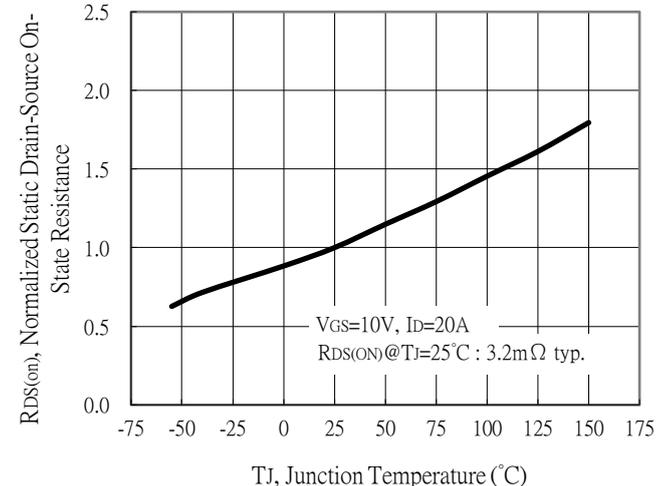
Body Diode Current vs Source-Drain Voltage



Static Drain-Source On-State Resistance vs Gate-Source Voltage

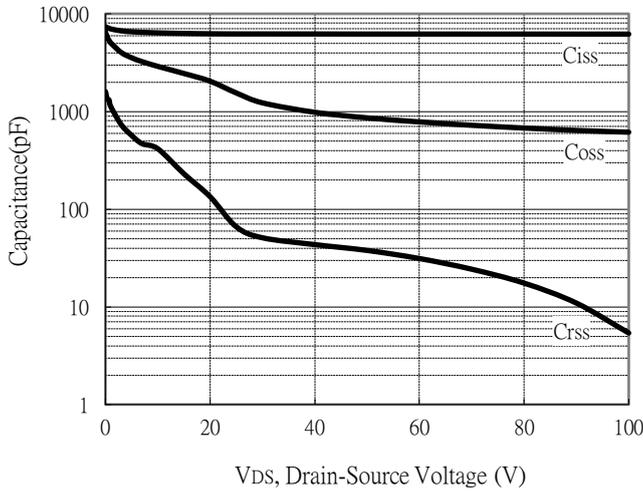


Drain-Source On-State Resistance vs Junction Temperature

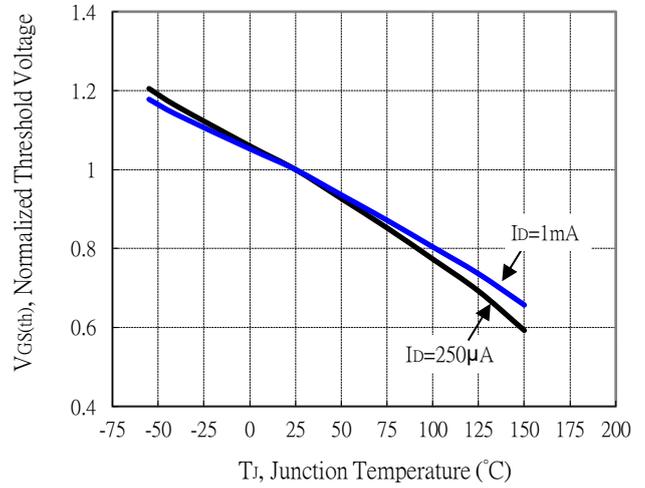


Typical Characteristics(Cont.)

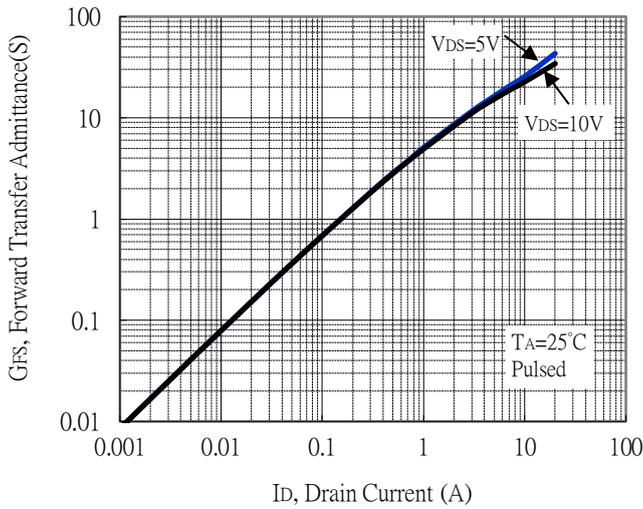
Capacitance vs Drain-to-Source Voltage



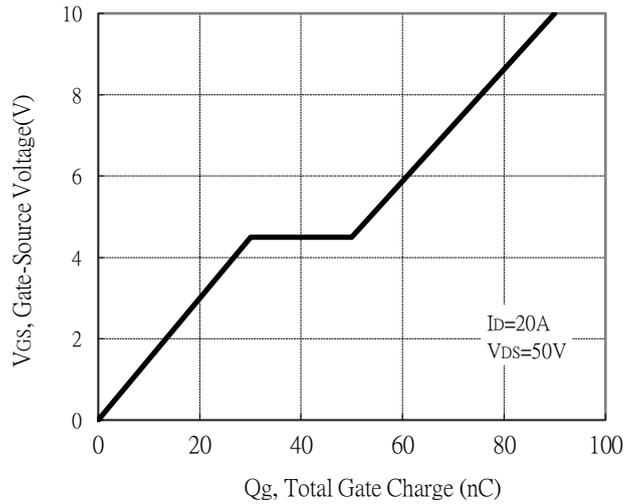
Threshold Voltage vs Junction Temperature



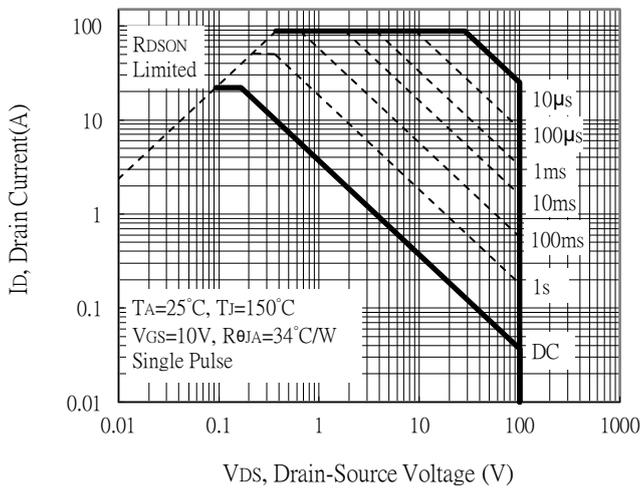
Forward Transfer Admittance vs Drain Current



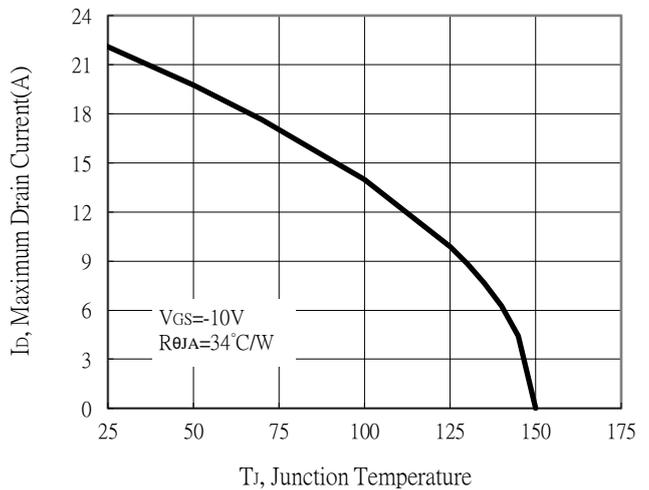
Gate Charge Characteristics



Maximum Safe Operating Area

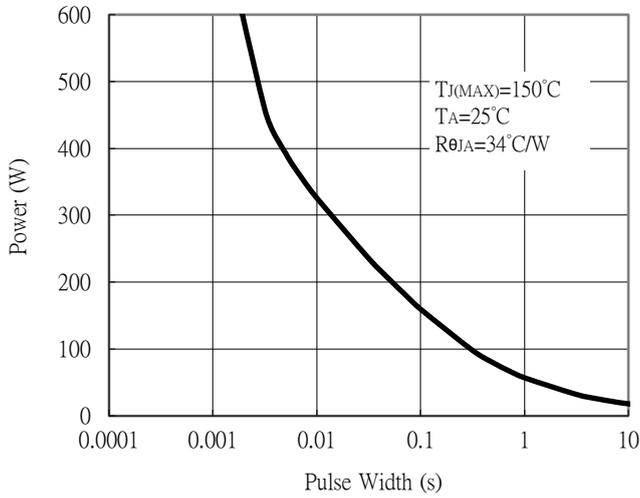


Maximum Drain Current vs Case Temperature

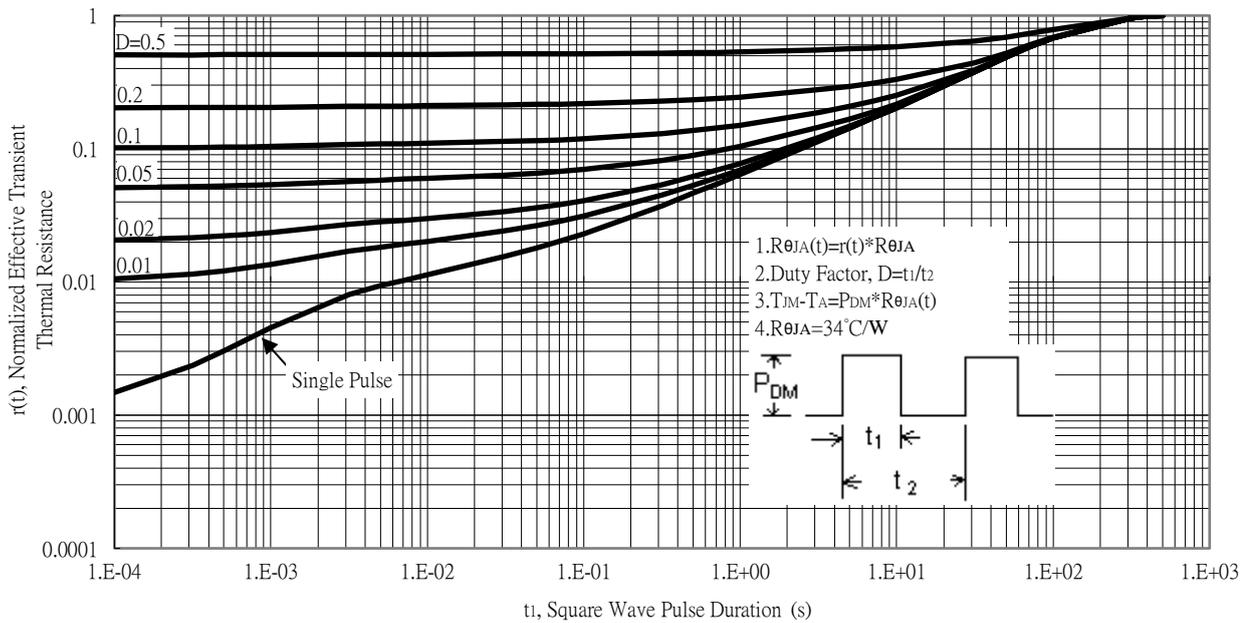


Typical Characteristics(Cont.)

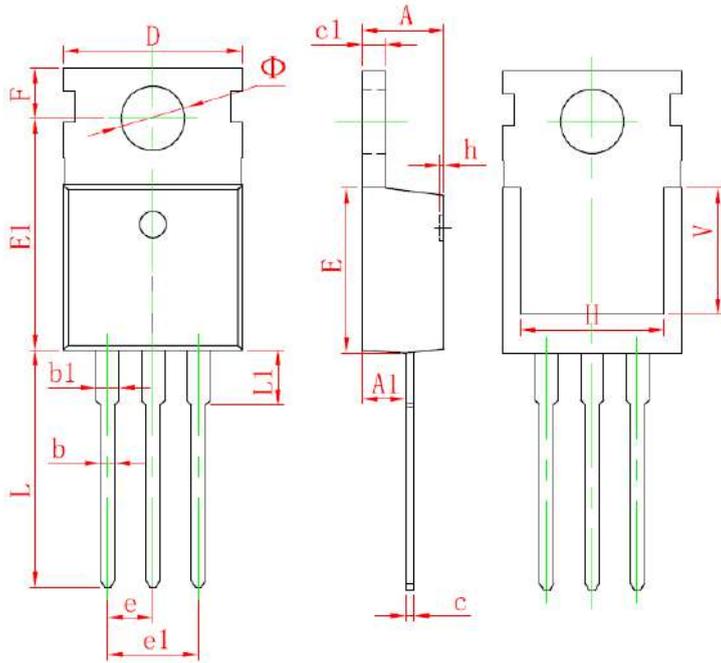
Single Pulse Power Rating, Junction to Ambient



Transient Thermal Response Curves

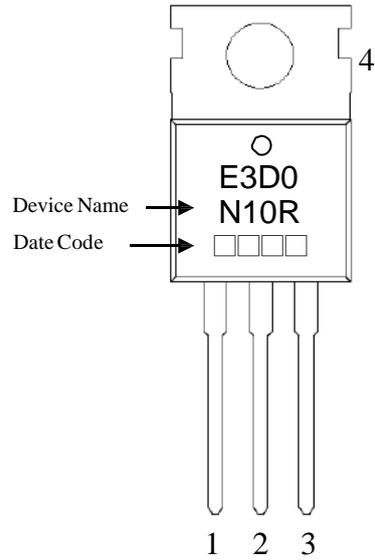


TO-220 Dimension



3-Lead TO-220 Plastic Package

Marking:



Style: Pin 1.Gate 2.Drain 3.Source
 4.Drain

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181	e	2.540*		0.100*	
A1	2.250	2.550	0.089	0.100	e1	4.980	5.180	0.196	0.204
b	0.710	0.910	0.028	0.036	F	2.650	2.950	0.104	0.116
b1	1.170	1.370	0.046	0.054	H	7.900	8.100	0.311	0.319
c	0.330	0.650	0.013	0.026	h	0.000	0.300	0.000	0.012
c1	1.200	1.400	0.047	0.055	L	12.900	13.400	0.508	0.528
D	9.910	10.250	0.390	0.404	L1	2.850	3.250	0.112	0.128
E	8.950	9.750	0.352	0.384	V	6.900	REF	0.271	REF
E1	12.650	13.050	0.498	0.514	Φ	3.400	3.800	0.134	0.150